

Abstract

A method for wetting a substrate with a fluid comprising the steps

- a) providing a substrate having a surface to be wetted;
- 5 b) providing a wetting fluid;
- c) applying to the substrate a protective layer that separates the surface to be wetted from the surroundings;
- d) patterning the protective layer to expose predetermined wetting areas on the substrate surface to be wetted; and
- 10 e) applying the wetting fluid to the exposed wetting areas by means of a wetting apparatus without direct contact between the wetting apparatus and the substrate surface to be wetted.

The invention also includes a substrate that is obtainable by said method.